Docket No.: 500.381 Q 20/485400 04-21-2000 FORM PTO-1595 U.S. DEPARTMENT OF HEET 1-31-92 COMMERCE Patent and Trademark Office med 7.10.00 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): Name and address of receiving party(ies): Kenji SEKINE Name: HITACHI, LTD. Hiroji YAMADA Matsuo YAMASAKI Street Address: 6, KANDA SURUGADAI 4-CHOME Osamu KAGAYA CHIYODA-KU Kiichi YAMASHITA 3. Nature of conveyance: City: TOKYO ☐ Merger Assignment Security Agreement ☐ Change of Name Country: JAPAN Other _ Execution Date: December 10,16, 1999 Yes No Additional name(s) & address(es) attached? 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: December 10,16, 1999 A. Patent Application No.(s) B. Patent No.(s) Yes No Additional numbers attached? 6. Total number of applications and patents involved: 1 5. Name and address of party to whom correspondence concerning document should be mailed: Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP 7. Total fee (37 CFR 3.41)\$40.00 Enclosed Any deficiencies may be charged to deposit account Internal Address: Authorized to be charged to deposit account 2000 MELAYBOR 00000036 094 Street Address: 1300 eventeenth Street 8. Deposit account number: 01-2135 (Attach duplicate copy of this page if paying by deposit account) Zip: 22209 City: Arlington State: VA DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document

William I. Solomon

Name of Person Signing

Attorney Registration No. 28,565

OMB No. 0651-0011 (exp. 4/94)

Total number of pages including cover sheet, attachments, and document: 2

PATENT

REEL: 010707 FRAME: 0900

February 10, 2000

Date

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

MULTICHIP MODULE STRUCTURE AND METHOD FOR MANUFACTURING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing. continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)	Date Signed
(発明者フルネームサイン)	(署名日)
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5) Kiichi Yomastuta	12/10/1988
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10)	

RECORDED: 02/10/2000

PATENT REEL: 010707 FRAME: 0901